

# NCE P-Channel Enhancement Mode Power MOSFET

#### Description

The NCE30P60G uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

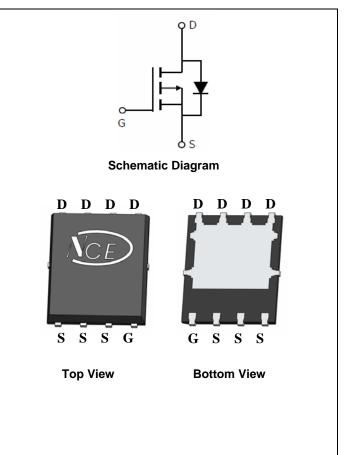
#### **General Features**

- $V_{DS} = -30V, I_D = -60A$   $R_{DS(ON)} < 6m\Omega @ V_{GS} = -10V$  $R_{DS(ON)} < 9m\Omega @ V_{GS} = -4.5V$
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

#### Application

• Battery and loading switching

#### 100% UIS TESTED!



#### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE30P60G	NCE30P60G	DFN 5x6	Ø330mm	12mm	5000 units

#### Absolute Maximum Ratings (T<sub>c</sub>=25<sup>°</sup>Cunless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	-30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι <sub>D</sub>	-60	А
Pulsed Drain Current	I <sub>DM</sub>	-240	A
Maximum Power Dissipation	PD	70	W
Derating factor		0. 56	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	980	mJ
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 150	°C

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	R <sub>θJC</sub>	1.79	°C/W	1
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#### Electrical Characteristics (TC=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·	·	·			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250µA	-30	-33	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-30V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)			•	•		
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250µA	-1.1	-1.6	-2.1	V
Drain Source On State Registeres		V <sub>GS</sub> =-10V, I <sub>D</sub> =-30A	-	4.5	6	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-30A	-	6.2	9	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =-5V,I <sub>D</sub> =-30A	-	20	-	S
Dynamic Characteristics (Note4)			•	•		
Input Capacitance	C <sub>lss</sub>		-	8469	_	PF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =-15V,V <sub>GS</sub> =0V, F=1.0MHz	-	1157	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	988	-	PF
Switching Characteristics (Note 4)	·	·	·			
Turn-on Delay Time	t <sub>d(on)</sub>		-	20	-	nS
Turn-on Rise Time	tr	V <sub>DD</sub> =-15V,I <sub>D</sub> =-30A	-	18	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	V <sub>DD</sub> =-15V,I <sub>D</sub> =-30A V <sub>GS</sub> =-10V,R <sub>GEN</sub> =6Ω	-	95	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	30	-	nS
Total Gate Charge	Qg	1/-15/(1-200)	-	118.7	-	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =-15V,I <sub>D</sub> =-30A, V <sub>GS</sub> =-10V	-	16.1	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =-10V	-	30.7	-	nC
Drain-Source Diode Characteristics		·	·			
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-30A	-	-0.85	-1.2	V
Diode Forward Current (Note 2)	I <sub>S</sub>		-	-	-60	А
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, IF = -30A	-	-	47	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-	-	78	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negli	igible (tur	n-on is do	minated b	y LS+LD)

#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

**2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.

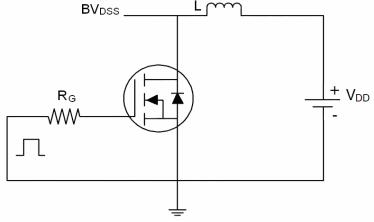
- **3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition:  $Tj=25^{\circ}C$ ,  $V_{DD}=-15V$ ,  $V_{G}=-10V$ , L=0.5mH,  $Rg=25\Omega$



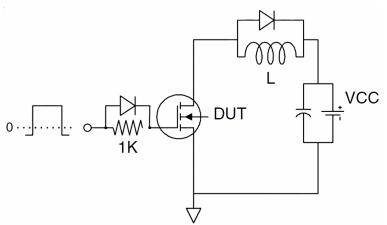
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# Test Circuit

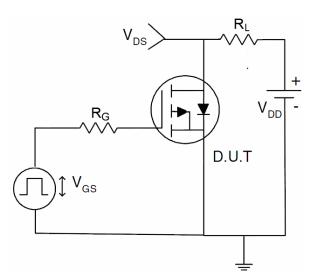
1) E<sub>AS</sub> Test Circuits



2) Gate Charge Test Circuit

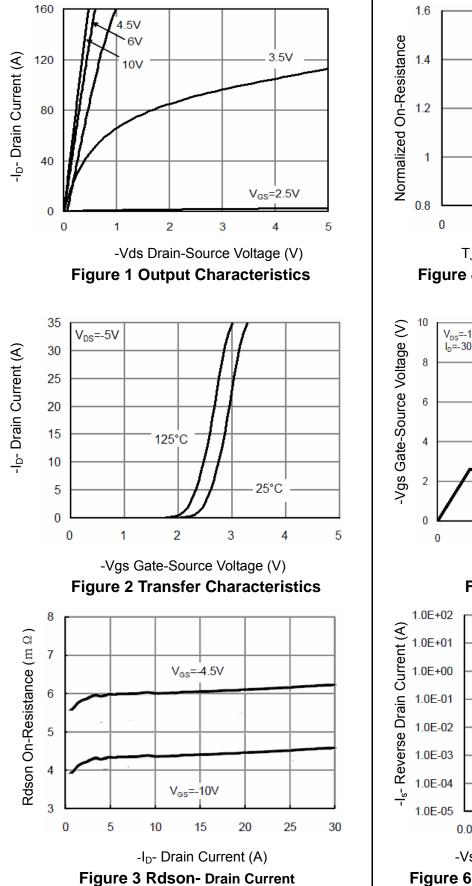


3) Switch Time Test Circuit









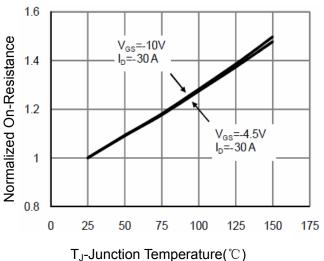
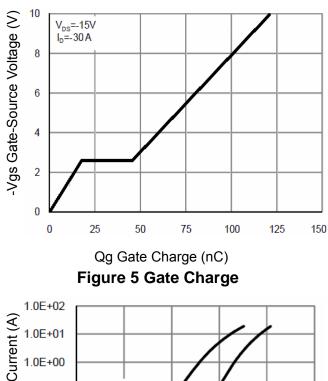
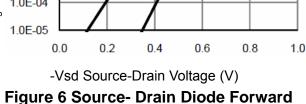


Figure 4 Rdson-Junction Temperature





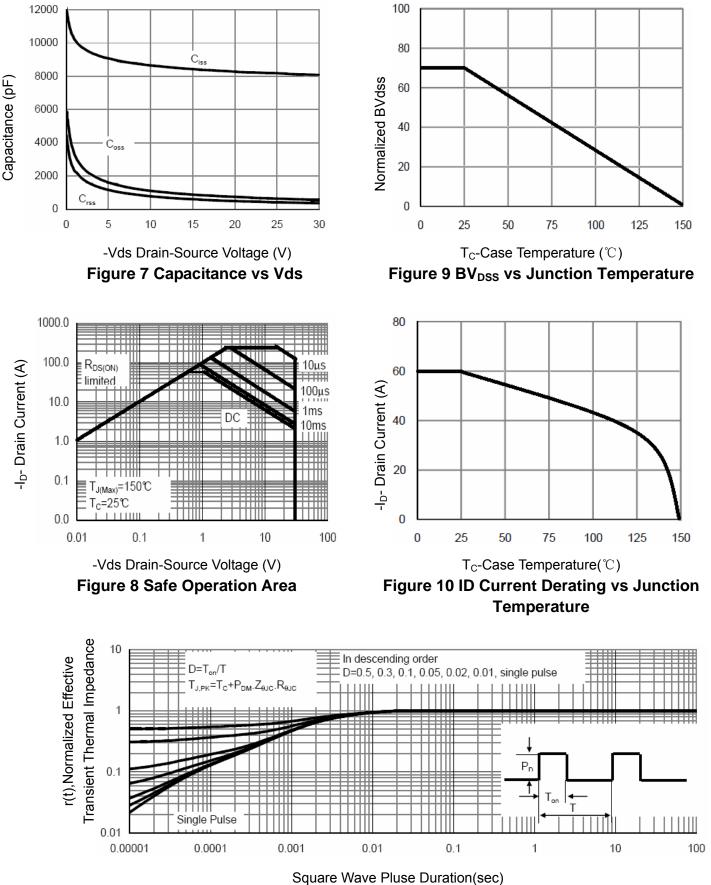
25° C

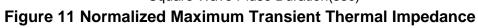
125°C



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# NCE30P60G

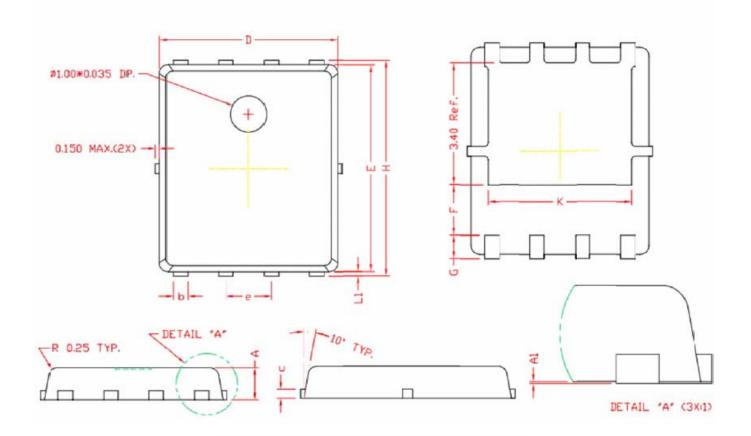






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### DFN5X6-8L Package Information



## COMMON DIMENSIONS

SYMBOL	MIN	NOM	MAX	
A	0.80	0.90	1.00	
A1	0.00	0.03	0.05	
b	0.35	0.42	0.49	
с	0.254 REF.			
D	4.90	5.00	5.10	
F	1.40 REF.			
E	5.70	5.80	5.90	
е	1.27 BSC.			
Н	5.95	6.08	6.20	
L1	0.10	0.14	0.18	
G	0.60 REF.			
K	4.00 REF.			

## (UNITS OF MEASURE=MILLIMETER)



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